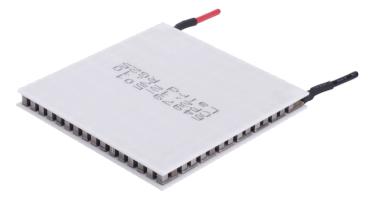
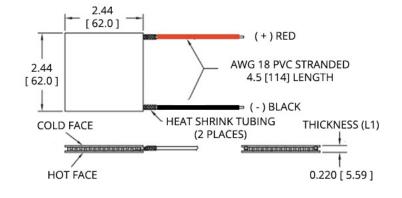
Ceramic Plate Series Thermoelectric Cooler

The CP2-127-10-L2-EP-W12 is a high-performance and highly reliable standard Thermoelectric Cooler. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics. It has a maximum Qc of 76.9 Watts when $\Delta T = 0$ and a maximum ΔT of 70.5 °C at Qc = 0.

Features

- Compact geometric sizes
- DC Operation
- RoHS-compliant
- Applications
- Thermoelectric Coolers for Reagent Storage
- Thermoelectric Coolers for Handheld Cosmetic Lasers
- Cooling for Centrifuges
- Heads-Up Displays, Imaging Sensors
- Peltier Cooling for Machine Vision



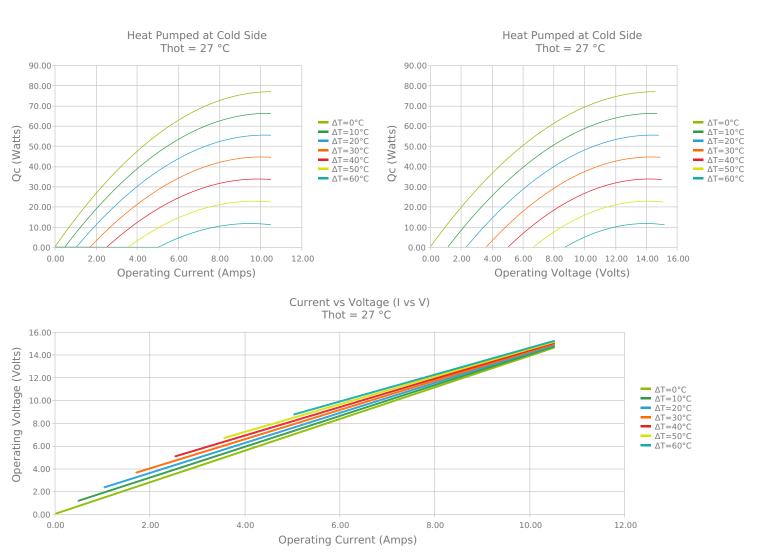


Ceramic Material: Alumina (Al₂O₃) Solder Construction: 138°C, Bismuth Tin (BiSn)

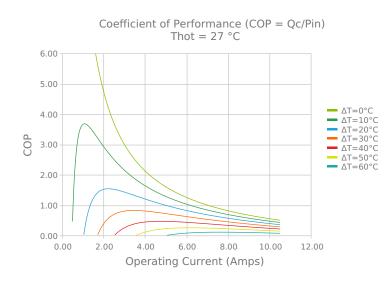
INCHES [MM]

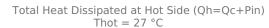
Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

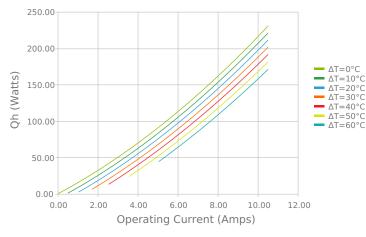
ELECTRICAL AND THERMAL PERFORMANCE

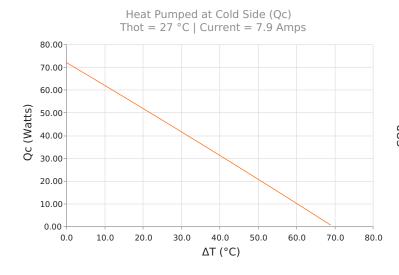


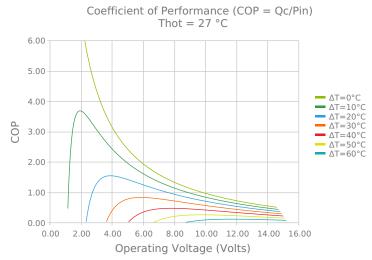
Laird

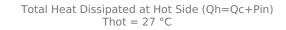


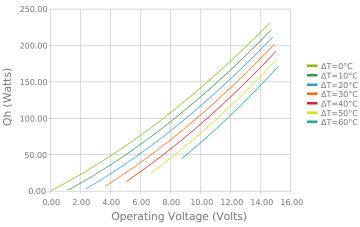




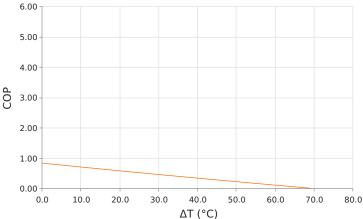








Coefficient of Performance (COP = Qc/Pin) Thot = $27 \degree C$ | Current = 7.9 Amps



SPECIFICATIONS*

Hot Side Temperature	27.0 °C	35.0 °C	50.0 °C
$Qcmax (\Delta T = 0)$	76.9 Watts	79.2 Watts	83.3 Watts
$\Delta Tmax (Qc = 0)$	70.5°C	73.5°C	78.8°C
lmax (I @ ΔTmax)	9.3 Amps	9.2 Amps	9.1 Amps
Vmax (V @ ΔTmax)	13.9 Volts	14.4 Volts	15.4 Volts
Module Resistance	1.39 Ohms	1.45 Ohms	1.56 Ohms
Max Operating Temperature	80 °C		
Weight	76.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
L2	5.588 ± 0.013 mm 0.220 ± 0.001 in	0.013 mm / 0.013 mm 0.0005 in / 0.0005 in	Lapped	Lapped	114.3 mm 4.50 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
EP	Ероху	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

NOTES

- 1. Max operating temperature: 80°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation
- 4. Solder tinning also available on metallized ceramics

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Date: 04/24/2020